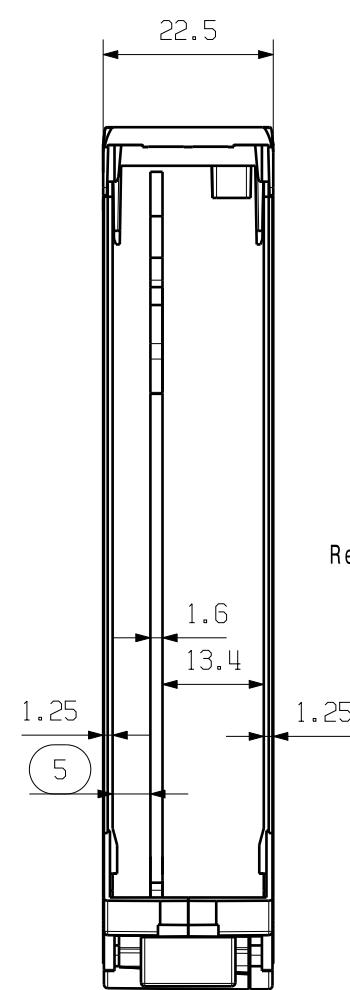
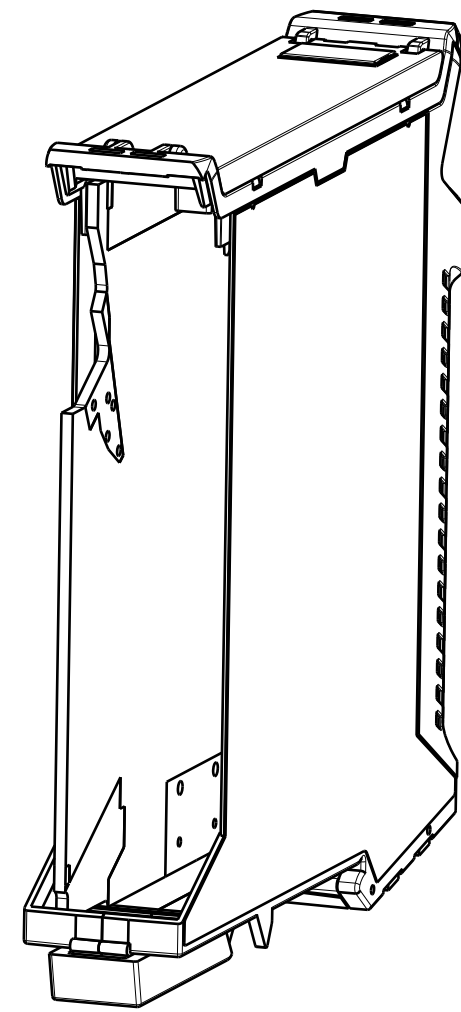


①
 Abstand Gehäuswand zur LP:
 Distance moulding wall to PCB: 2.3mm
 Darstellung der Position der Stiftleisten siehe (Z.-Nr.): CH20M A OV PCB-SHL (70315)
 Representation of the position of the pin headers see (d.no.):



①
 Abstand Gehäuswand zur LP:
 Distance moulding wall to PCB: 5.0mm
 Darstellung der Position der Stiftleisten siehe (Z.-Nr.): CH20M A OV PCB-SHL (70315)
 Representation of the position of the pin headers see (d.no.):

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EC00004186	Prim PLM Part No.: 1159544	Prim ERP Part No.:
First Issue Date 28.06.2019	Max. nos.	
	Modification	
	Drawn	25.11.2020 Niggemann, Mat
	Responsible	Niggemann, Mat
	Approved	12.01.2021 Püschner, Klau
Scale: 1/1	Size: A3	Product file: 5670 CH20...

50881
 Drawing no. Issue no.
 Sheet 01 of 01 sheets

LP-POSITION 22MM
 LEITERPLATTEN-POSITION
 PCB-POSITION